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# CYLINDRICAL MAGNETRON DEVELOPMENT FOR Nb<sub>3</sub>Sn **DEPOSITION VIA MAGNETRON SPUTTERING**

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M. N. Sayeed, H. E. Elsayed-Ali, Old Dominion University, Norfolk, Virginia, USA, G. V. Eremeev, Fermi National Accelerator Laboratory, Batavia, Illinois, USA A.M. Valente-Feliciano, Thomas Jefferson National Accelerator Facility, Newport News, Virginia, USA, C. Côté, M. Farzad, M. Patterson, A. Chang, A. Sarkissian, PLASMIONIQUE Inc., Varennes, QC, Canada.

# Abstract

Due to its better superconducting properties (critical temperature  $T_c \sim 18.3$  K, superheating field  $H_{sh} \sim 400$  mT), Nb<sub>3</sub>Sn is considered as a potential alternative to niobium ( $T_c \sim 9.25$  K,  $H_{sh} \sim 200$  mT) for superconducting radiofrequency (SRF) cavities for particle acceleration. Magnetron sputtering is an effective method to produce superconducting Nb<sub>3</sub>Sn films. We deposited superconducting Nb<sub>3</sub>Sn films on samples with magnetron sputtering using co-sputtering, sequential sputtering, and sputtering from a stoichiometric target. Nb<sub>3</sub>Sn films produced by magnetron sputtering in our previous experiments achieved DC superconducting critical temperature up to 17.93 K and RF superconducting transition at 17.2 K. A magnetron sputtering system with two identical cylindrical cathodes that can be used to sputter Nb<sub>3</sub>Sn films on cavities has been designed and is under development now. We report on the design and the current progress on the development of the system.



# Nb<sub>3</sub>Sn fabrication processes and results

### **Process** 1

Sputtering was performed at a 3 mTorr Ar pressure with a constant DC current of 150 mA on a substrate heated up to 800 °C.

#### **Parameters optimized**

✤ Deposition pressure ✤ Substrate temperature ✤ Annealing temperature Annealing time

### **Film properties:**

• Good  $T_c \sim 17.83$  K  $\mathbf{*}$  Nb<sub>3</sub>Sn phase only Sn rich clusters ✤ Sn deficiency on surface

### **Process 2**

**Parameters optimized** 

✤ Thickness of multilayers

Substrate temperature

✤ Annealing temperature

**Film properties:** 

• Good  $T_c \sim 17.93$  K

✤ Nb<sub>3</sub>Sn phase only

✤ Voids are observed

after annealing

✤ Sn deficiency were found

✤ Annealing time

The powers of both targets Multiple layers of Nb and were optimized to maintain Sn films with a thickness of the film stoichiometry and 20 and 10 nm respectively. the cosputtered samples The multilayers were were further annealed. annealed at 950 °C for 3 h.

# **Parameters optimized**

Nb:Sn power ratio ✤ Substrate temperature

**Process 3** 

✤ Annealing temperature

#### **Film properties:** • Good $T_c \sim 17.60 \text{ K}$ $\mathbf{*}$ Nb<sub>3</sub>Sn phase only

✤ No voids Sn deficiency observed after annealing

individual magnetron: A. inlet, B. water water outlet, C. magnets, D. magnet spacers, E. target.

# **Plasma Discharge**

sputtering chamber

with the 2.6 GHz RF





the

cavity.











Test station for plasma discharge.



Observation of plasma discharge with 40 W at 10 mTorr.

Picture of the coated sample placed in front of the discharge with about 100 W. A mirror coating was obtained in couple of minutes. The delaminated ring at the right side of the confirms a thick layer.

Plasma discharge obtained inside a tube identical to the beam tube of the 2.6 GHz DC The cavity. breakdown voltage at 5 and 20 mTorr was about 300 and 230 V, respectively.

# Conclusion

A cylindrical magnetron sputtering system has been designed to fabricate Nb<sub>3</sub>Sn films inside a 2.6 GHz cavity. The simulation and experimental results validated the design for SRF cavity coating. The fabrication procedure of the sputtering system has been initiated to commission the system for 2.6 GHz SRF cavity coating in 2021.

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# Cylindrical magnetron sputtering system

A cylindrical magnetron sputtering system for deposition of a multilayer Nb and Sn layers, with its associated computer control unit has been designed and fabricated by PLASMIONIQUE Inc. The goal of our current research is to establish a multilayer sputtering system to deposit Nb<sub>3</sub>Sn films inside a single cell RF cavity. The system will be optimized further to apply cosputtering and sputtering from a stoichiometric target.











